

POCKET OFF-SET (IF APPLICABLE)	
mm	INCHES

TEMPLATE OUTSIDE DIAMETER	
mm	INCHES

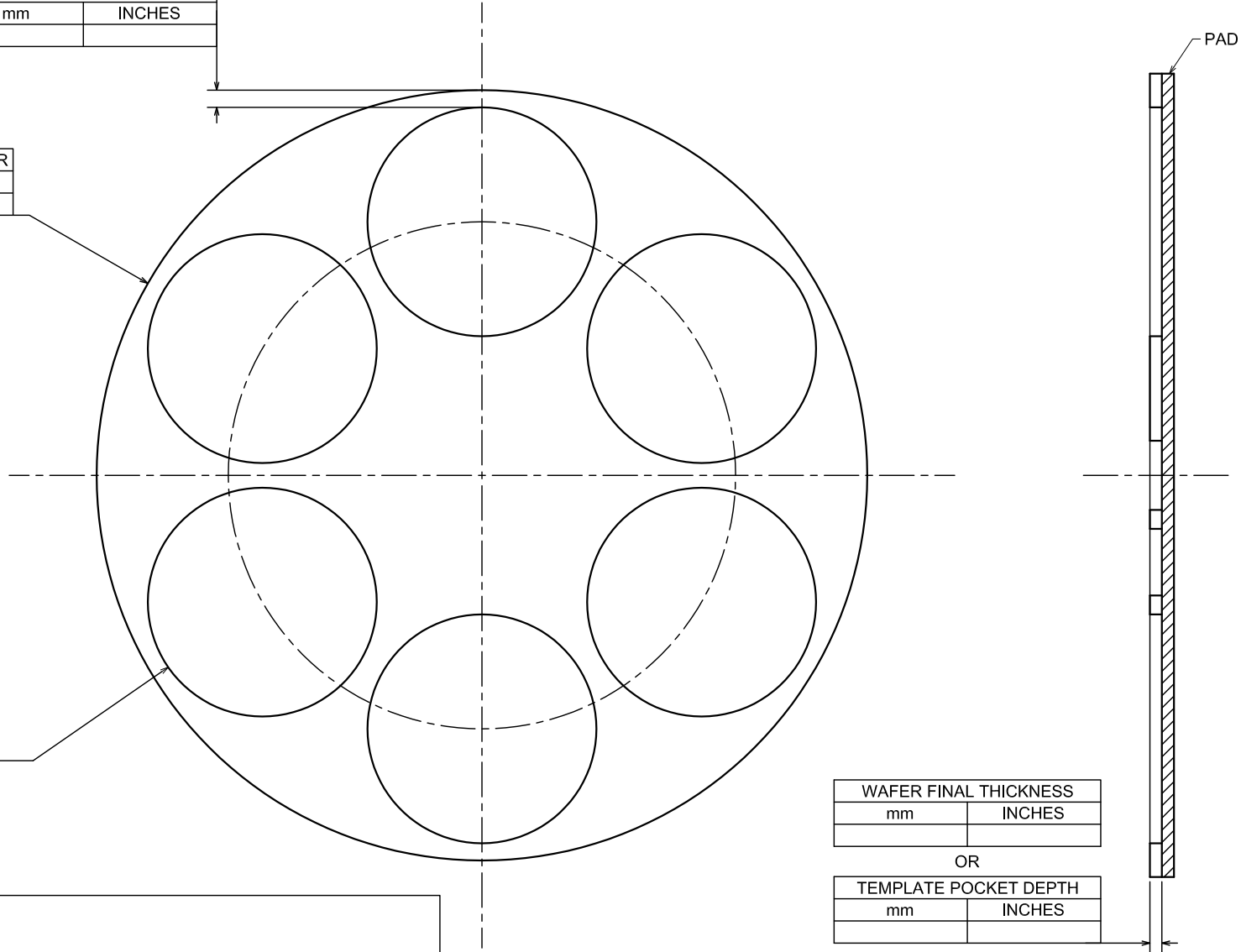
TEMPLATE POCKET DIMENSIONS	
mm	INCHES

OR

MAX WAFER DIMENSIONS	
mm	INCHES

AND

NUMBER OF POCKETS (IF KNOWN)



WAFER FINAL THICKNESS	
mm	INCHES

OR

TEMPLATE POCKET DEPTH	
mm	INCHES


CUSTOMER NOTES:

APPROVED: _____		DATE: _____	
REV	DESCRIPTION	DATE	SIGN

CUSTOMER				
MATERIAL				
G-10				
POROMERIC BACKING PAD				
DO NOT SCALE DRAWING	UNITS	DRAW BY	DATE	REV

DESCRIPTION	
PRODUCT: TEMPLATE	

TOLERANCES
UNLESS OTHERWISE
SPECIFIED
.X ± 0.25
.XX ± 0.13
.XXX ± 0.013
ANGULAR
± 0.5°



Ceiba Technologies
410 N. Roosevelt Avenue Chandler AZ 85225
Phone (480)705 4541 Fax (480)705 5236

CUSTOMER REF. #	CEIBA PART #